

## Microprocessor-Compatible Sampling CMOS ANALOG-TO-DIGITAL CONVERTER

### FEATURES

- Drop-In Replacement for the [ADS774](#)
- Complete Sampling ADC with Reference, Clock, and Microprocessor Interface
- Fast Acquisition and Conversion: 8.5μs Max Over Temperature
- Eliminates External Sample/Hold in Most Applications
- Ensured AC and DC Performance
- Single +5V Supply Operation
- Low Power: 120mW Max
- Package Options: SO, 0.6in and 0.3in DIPs<sup>(1)</sup>

### APPLICATIONS

- Medical Instrumentation
- Data Acquisition Systems
- Robotics
- Industrial Control
- Test Equipment
- Digital Signal Processing
- DSP Servo Control

### DESCRIPTION

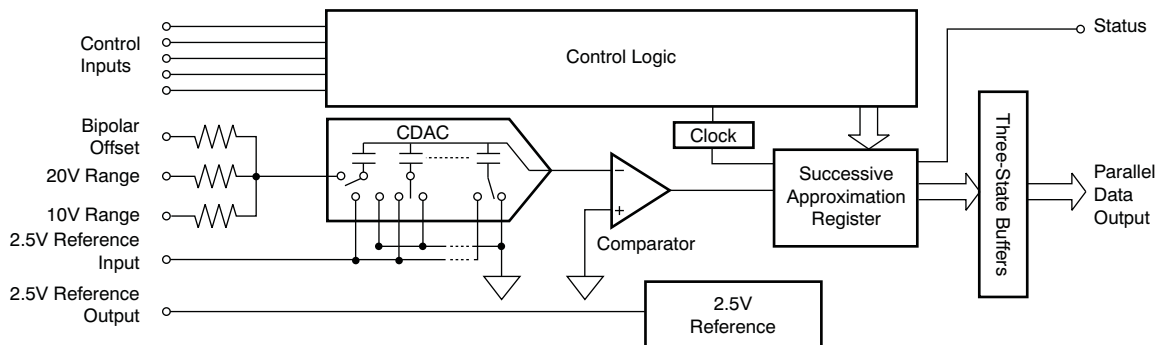
The ADS774H is a 12-bit, successive-approximation analog-to-digital converter (ADC) that uses an innovative capacitor array (CDAC) implemented in low-power CMOS technology. This device is a drop-in replacement for the [ADS774](#), with internal sampling, much lower power consumption, and the ability to operate from a single +5V supply.

The ADS774H is complete with an internal clock, microprocessor interface, three-state outputs, and internal scaling resistors for input ranges of 0V to +10V, 0V to +20V, ±5V, or ±10V. The maximum throughput time is 8.5μs over the full operating temperature range, including both acquisition and conversion.

Complete user control over the internal sampling function facilitates elimination of external sample/hold amplifiers in most existing designs.

The ADS774H requires +5V, with –15V optional. No +15V supply is required. Packages include a 28-pin SO, and 0.3in-wide or 0.6in-wide 28-pin DIPs<sup>(1)</sup>.

(1) DIP-28 package is product preview.



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### PACKAGE/ORDERING INFORMATION<sup>(1)</sup>

| PRODUCT                      | SINAD <sup>(2)</sup> | LINEARITY ERROR | PACKAGE-LEAD          | PACKAGE DESIGNATOR | SPECIFIED TEMPERATURE RANGE | ORDERING NUMBER | TRANSPORT MEDIA, QUANTITY |
|------------------------------|----------------------|-----------------|-----------------------|--------------------|-----------------------------|-----------------|---------------------------|
| ADS774HIB<br>(High-Grade)    | 70dB                 | ±1/2 LSB        | DIP-28 <sup>(3)</sup> | NT                 | –40°C to +85°C              | ADS774HIBNT     | Rail, 13                  |
|                              |                      |                 |                       | NTD                | –40°C to +85°C              | ADS774HIBNTD    | Rail, 13                  |
|                              | 70dB                 | ±1/2 LSB        | SO-28                 | DW                 | –40°C to +85°C              | ADS774HIBDW     | Tape and Reel, 28         |
|                              |                      |                 |                       |                    |                             | ADS774HIBEDWR   | Tape and Reel, 1000       |
| ADS774HI<br>(Standard-Grade) | 68dB                 | ±1LSB           | DIP-28 <sup>(3)</sup> | NT                 | –40°C to +85°C              | ADS774HINTD     | Rail, 13                  |
|                              |                      |                 |                       | NTD                | –40°C to +85°C              | ADS774HINT      | Rail, 13                  |
|                              | 68dB                 | ±1LSB           | SO-28                 | DW                 | –40°C to +85°C              | ADS774HIDW      | Tape and Reel, 28         |
|                              |                      |                 |                       |                    |                             | ADS774HIDWR     | Tape and Reel, 1000       |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) SINAD is Signal-to-(Noise + Distortion) expressed in dB.
- (3) DIP-28 package is product preview.

### ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Over operating free-air temperature range (unless otherwise noted).

|                                                                                                                       |        | ADS774H                                                 | UNIT |
|-----------------------------------------------------------------------------------------------------------------------|--------|---------------------------------------------------------|------|
| $V_{EE}$ to Digital Common                                                                                            |        | + $V_{DD}$ to –16.5                                     | V    |
| $V_{DD}$ to Digital Common                                                                                            |        | 0 to +7                                                 | V    |
| Analog Common to Digital Common                                                                                       |        | ±1                                                      | V    |
| Control inputs ( $\overline{CE}$ , $\overline{CS}$ , $A_0$ , $12/\overline{8}$ , $R/\overline{C}$ ) to Digital Common |        | –0.5 to $V_{DD}$ +0.5                                   | V    |
| Analog inputs (REF IN, Bipolar Offset, 10V Range) to Analog Common                                                    |        | ±16.5                                                   | V    |
| 20V Range to Analog Common                                                                                            |        | ±24                                                     | V    |
| Ref Out                                                                                                               |        | Indefinite short to common, momentary short to $V_{DD}$ |      |
| Maximum junction temperature                                                                                          |        | +165                                                    | °C   |
| Power dissipation                                                                                                     |        | 1000                                                    | mW   |
| Lead temperature (soldering, 10s)                                                                                     |        | +300                                                    | °C   |
| Thermal impedance, $\theta_{JA}$                                                                                      | DIP-28 | 100                                                     | °C/W |
|                                                                                                                       | SO-28  |                                                         |      |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

All specifications at  $T_A = T_{MIN}$  to  $T_{MAX}$ ,  $V_{DD} = +5V$ ,  $V_{EE} = -15V$  to  $+5V$ , sampling frequency of 117kHz, and  $f_{IN} = 10kHz$ , unless otherwise noted.

| PARAMETER                                                                                       | CONDITIONS                                          | ADS774HI              |     |      | ADS774HIB <sup>(1)</sup> |     |       | UNIT                   |
|-------------------------------------------------------------------------------------------------|-----------------------------------------------------|-----------------------|-----|------|--------------------------|-----|-------|------------------------|
|                                                                                                 |                                                     | MIN                   | TYP | MAX  | MIN                      | TYP | MAX   |                        |
| SYSTEM PERFORMANCE                                                                              |                                                     |                       |     |      |                          |     |       |                        |
| Resolution                                                                                      |                                                     | 12                    |     |      | 12                       |     |       | Bits                   |
| ANALOG INPUTS                                                                                   |                                                     |                       |     |      |                          |     |       |                        |
| Voltage range                                                                                   | Unipolar                                            | 0 to +10,<br>0 to +20 |     |      | 0 to +10,<br>0 to +20    |     |       | V                      |
|                                                                                                 | Bipolar                                             | ±5, ±10               |     |      | ±5, ±10                  |     |       | V                      |
| Impedance                                                                                       | 0V to +10V, ±5V                                     | 8.5                   | 12  |      | 8.5                      | 12  |       | kΩ                     |
|                                                                                                 | ±10V, 0V to +20V                                    | 35                    | 50  |      | 35                       | 50  |       | kΩ                     |
| DIGITAL INPUTS (CE, $\overline{CS}$ , R/ $\overline{C}$ , A <sub>0</sub> , 12/ $\overline{8}$ ) |                                                     |                       |     |      |                          |     |       |                        |
| Voltages                                                                                        | Logic 1                                             | +2.0                  |     | +5.5 | +2.0                     |     | +5.5  | V                      |
|                                                                                                 | Logic 0                                             | −0.5                  |     | +0.8 | −0.5                     |     | +0.8  | V                      |
| Current                                                                                         |                                                     | −5                    | 0.1 | +5   | −5                       | 0.1 | +5    | μA                     |
| Capacitance                                                                                     |                                                     | 5                     |     |      | 5                        |     |       | pF                     |
| DC ACCURACY                                                                                     |                                                     |                       |     |      |                          |     |       |                        |
| Linearity error                                                                                 | At +25°C                                            | ±1                    |     |      |                          |     | ±1/2  | LSB                    |
|                                                                                                 | T <sub>MIN</sub> to T <sub>MAX</sub> <sup>(2)</sup> | ±1                    |     |      |                          |     | ±1/2  | LSB                    |
| Unipolar offset error                                                                           | At +25°C (adjustable to zero)                       | ±2                    |     |      | ±2                       |     |       | LSB                    |
| Unipolar offset                                                                                 | T <sub>MIN</sub> to T <sub>MAX</sub> <sup>(2)</sup> | ±4                    |     |      |                          |     | ±3    | LSB                    |
| Bipolar offset error                                                                            | At +25°C (adjustable to zero)                       | ±10                   |     |      | ±4                       |     |       | LSB                    |
| Bipolar offset                                                                                  | T <sub>MIN</sub> to T <sub>MAX</sub> <sup>(2)</sup> | ±12                   |     |      |                          |     | ±5    | LSB                    |
| Full-scale calibration error <sup>(3)</sup>                                                     | At +25°C (adjustable to zero)                       | ±0.25                 |     |      | ±0.25                    |     |       | % of FS <sup>(4)</sup> |
|                                                                                                 | T <sub>MIN</sub> to T <sub>MAX</sub> <sup>(2)</sup> | ±0.47                 |     |      |                          |     | ±0.37 | % of FS                |
| No missing codes resolution                                                                     | At +25°C                                            | 12                    |     |      | 12                       |     |       | Bits                   |
|                                                                                                 | T <sub>MIN</sub> to T <sub>MAX</sub> <sup>(2)</sup> | 12                    |     |      | 12                       |     |       | Bits                   |
| AC ACCURACY <sup>(5)</sup>                                                                      |                                                     |                       |     |      |                          |     |       |                        |
| Spurious free dynamic range                                                                     |                                                     | 73                    | 78  |      | 76                       | 78  |       | dB                     |
| Total harmonic distortion                                                                       |                                                     |                       | −77 | −72  |                          | −77 | −75   | dB                     |
| Signal-to-noise ratio                                                                           |                                                     | 69                    | 72  |      | 71                       | 72  |       | dB                     |
| Signal-to-(noise + distortion) ratio                                                            |                                                     | 68                    | 71  |      | 70                       | 71  |       | dB                     |
| Intermodulation distortion                                                                      | f <sub>IN1</sub> = 20kHz, f <sub>IN2</sub> = 23kHz  | −75                   |     |      | −75                      |     |       | dB                     |
| TEMPERATURE COEFFICIENTS <sup>(6)</sup>                                                         |                                                     |                       |     |      |                          |     |       |                        |
| Unipolar offset                                                                                 |                                                     | ±1                    |     |      | ±1                       |     |       | ppm/°C                 |
| Bipolar offset                                                                                  |                                                     | ±2                    |     |      | ±2                       |     |       | ppm/°C                 |
| Full-scale calibration                                                                          |                                                     | ±12                   |     |      | ±12                      |     |       | ppm/°C                 |
| POWER-SUPPLY SENSITIVITY                                                                        |                                                     |                       |     |      |                          |     |       |                        |
| Change in full-scale calibration <sup>(7)</sup>                                                 | +4.75V < V <sub>DD</sub> < +5.25V                   | ±1/2                  |     |      | ±1/2                     |     |       | LSB                    |
| CONVERSION TIME (Including Acquisition Time)                                                    |                                                     |                       |     |      |                          |     |       |                        |
| t <sub>AQ</sub> + t <sub>C</sub> at +25°C                                                       | 8-bit cycle                                         | 5.5                   | 5.9 |      | 5.5                      | 5.9 |       | μs                     |
|                                                                                                 | 12-bit cycle                                        | 7.5                   | 8   |      | 7.5                      | 8   |       | μs                     |
| 12-bit cycle, T <sub>MIN</sub> to T <sub>MAX</sub>                                              |                                                     | 8                     | 8.5 |      | 8                        | 8.5 |       | μs                     |

(1) Shaded cells indicate different specifications from standard grade version of device.

(2) Maximum error at  $T_{MIN}$  and  $T_{MAX}$ .

(3) With fixed 50Ω resistor from REF OUT to REF IN. This parameter is also adjustable to zero at +25°C.

(4) FS in this parametric table means *Full-Scale Range*. That is, for a ±10V input range, FS = 20V; for a 0V to +10V range, FS = 10V.

(5) Based on  $V_{EE} = +5V$ , which is the Control Mode; see the *S/H Control Mode and ADC774 Emulation Mode* section.

(6) Using internal reference.

(7) This parameter is the worst-case change in accuracy from accuracy with a +5V supply.

## ELECTRICAL CHARACTERISTICS (continued)

All specifications at  $T_A = T_{MIN}$  to  $T_{MAX}$ ,  $V_{DD} = +5V$ ,  $V_{EE} = -15V$  to  $+5V$ , sampling frequency of 117kHz, and  $f_{IN} = 10kHz$ , unless otherwise noted.

| PARAMETER                                                      | CONDITIONS                            | ADS774HI                       |      |      | ADS774HIB <sup>(1)</sup>       |      |      | UNIT   |
|----------------------------------------------------------------|---------------------------------------|--------------------------------|------|------|--------------------------------|------|------|--------|
|                                                                |                                       | MIN                            | TYP  | MAX  | MIN                            | TYP  | MAX  |        |
| SAMPLING DYNAMICS                                              |                                       |                                |      |      |                                |      |      |        |
| Sampling rate                                                  | At +25°C                              | 125                            |      |      | 125                            |      |      | kHz    |
|                                                                | T <sub>MIN</sub> to T <sub>MAX</sub>  | 117                            |      |      | 117                            |      |      | kHz    |
| Aperture delay, t <sub>AP</sub>                                | with V <sub>EE</sub> = +5V            | 20                             |      |      | 20                             |      |      | ns     |
|                                                                | with V <sub>EE</sub> = 0V to −15V     | 1.6                            |      |      | 1.6                            |      |      | μs     |
| Aperture uncertainty (jitter)                                  | with V <sub>EE</sub> = +5V            | 300                            |      |      | 300                            |      |      | ps RMS |
|                                                                | with V <sub>EE</sub> = 0V to −15V     | 10                             |      |      | 10                             |      |      | ns RMS |
| Settling time to 0.01% for full-scale input change             |                                       | 1.4                            |      |      | 1.4                            |      |      | μs     |
| DIGITAL OUTPUTS (DB <sub>11</sub> to DB <sub>0</sub> , STATUS) |                                       |                                |      |      |                                |      |      |        |
| Output codes                                                   | Unipolar                              | Unipolar straight binary (USB) |      |      | Unipolar straight binary (USB) |      |      |        |
|                                                                | Bipolar                               | Bipolar offset binary (BOB)    |      |      | Bipolar offset binary (BOB)    |      |      |        |
| Logic levels                                                   | Logic 0 (I <sub>SINK</sub> = 1.6mA)   | +0.4                           |      |      | +0.4                           |      |      | V      |
|                                                                | Logic 1 (I <sub>SOURCE</sub> = 500μA) | +2.4                           |      |      | +2.4                           |      |      | V      |
| Leakage, data bits only, high-Z state                          |                                       | −5                             | 0.1  | +5   | −5                             | 0.1  | +5   | μA     |
| Capacitance                                                    |                                       | 5                              |      |      | 5                              |      |      | pF     |
| INTERNAL REFERENCE VOLTAGE                                     |                                       |                                |      |      |                                |      |      |        |
| Voltage                                                        |                                       | +2.4                           | +2.5 | +2.6 | +2.4                           | +2.5 | +2.6 | V      |
| Source current available for external loads                    |                                       | 0.5                            |      |      | 0.5                            |      |      | mA     |
| POWER-SUPPLY REQUIREMENTS                                      |                                       |                                |      |      |                                |      |      |        |
| Voltage                                                        | V <sub>EE</sub> <sup>(8)</sup>        | −16.5                          |      |      | −16.5                          |      |      | V      |
|                                                                | V <sub>DD</sub>                       | +4.5                           |      |      | +4.5                           |      |      | V      |
| Current                                                        | I <sub>EE</sub> <sup>(8)</sup>        | −1                             |      |      | −1                             |      |      | mA     |
|                                                                | I <sub>DD</sub>                       | +15                            |      |      | +15                            |      |      | mA     |
| Power dissipation, t <sub>MIN</sub> to t <sub>MAX</sub>        | V <sub>EE</sub> = 0V to +5V           | 75                             |      |      | 75                             |      |      | mW     |
| TEMPERATURE RANGE                                              |                                       |                                |      |      |                                |      |      |        |
| Specified                                                      |                                       | −40                            |      |      | −40                            |      |      | °C     |
| Operating                                                      |                                       | −40                            |      |      | −40                            |      |      | °C     |
| Storage                                                        |                                       | −65                            |      |      | −65                            |      |      | °C     |

(8)  $V_{EE}$  is optional, and is only used to set the mode for the internal sample/hold. When  $V_{EE} = -15V$ ,  $I_{EE} = -1mA$  typ; when  $V_{EE} = 0V$ ,  $I_{EE} = \pm 5mA$  typ; when  $V_{EE} = +5V$ ,  $I_{EE} = +167mA$  typ.

## TIMING DIAGRAMS

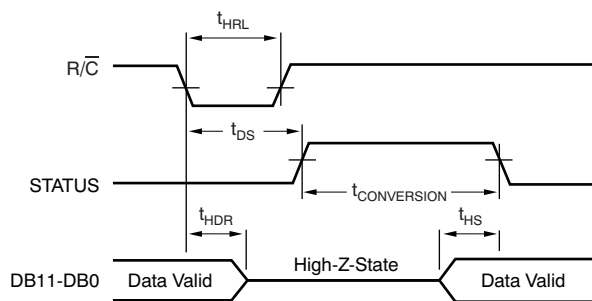


**Figure 1. R/C Pulse Low: Outputs Enabled After Conversion**

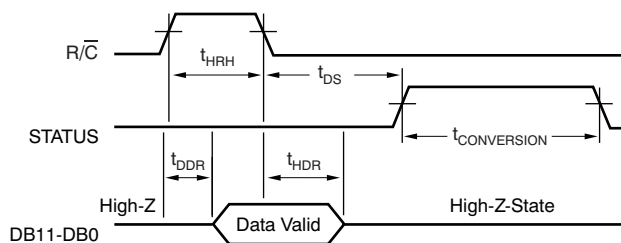
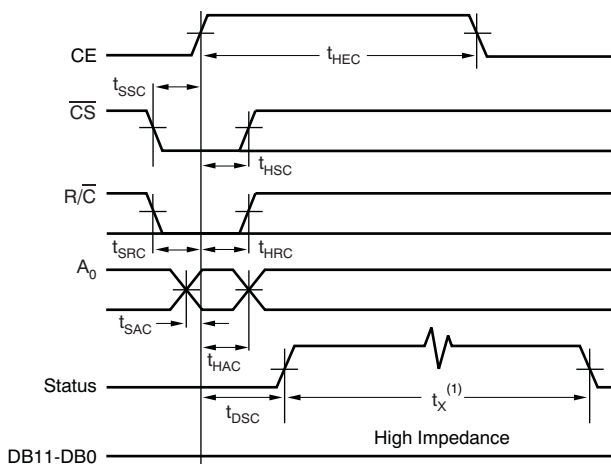


**Figure 2. R/C Pulse High: Outputs Enabled Only when R/C is High**



NOTE (1):  $t_X$  includes  $t_{AQ}$  and  $t_C$  in ADC774 Emulation Mode,  $t_C$  only in S/H Control Mode.

**Figure 3. Conversion Cycle Timing**

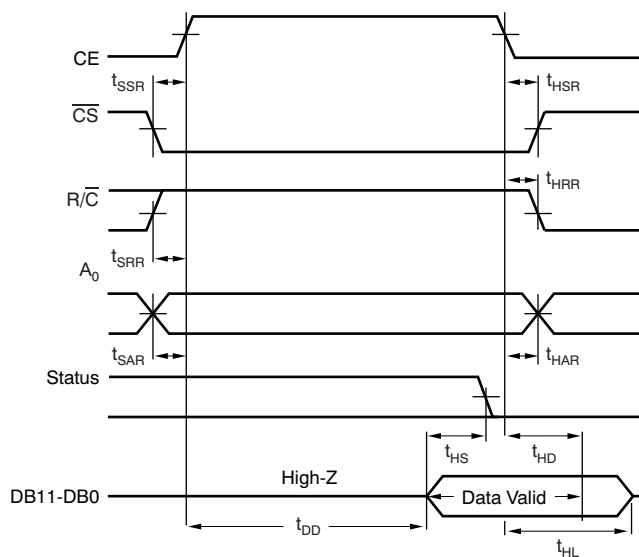


**Figure 4. Read Cycle Timing**

**TIMING REQUIREMENTS: Stand-Alone Mode**

| SYMBOL    | PARAMETER                             | ADS774H |     |     | UNIT |
|-----------|---------------------------------------|---------|-----|-----|------|
|           |                                       | MIN     | TYP | MAX |      |
| $t_{HRL}$ | Low $R/\overline{C}$ pulse width      | 25      |     |     | ns   |
| $t_{DS}$  | STS delay from $R/\overline{C}$       |         |     | 200 | ns   |
| $t_{HDR}$ | Data valid After $R/\overline{C}$ low | 25      |     |     | ns   |
| $t_{HRH}$ | High $R/\overline{C}$ pulse width     | 100     |     |     | ns   |
| $t_{DDR}$ | Data access time                      |         |     | 150 | ns   |

**TIMING REQUIREMENTS: Fully-Controlled Operation (Convert Mode)**

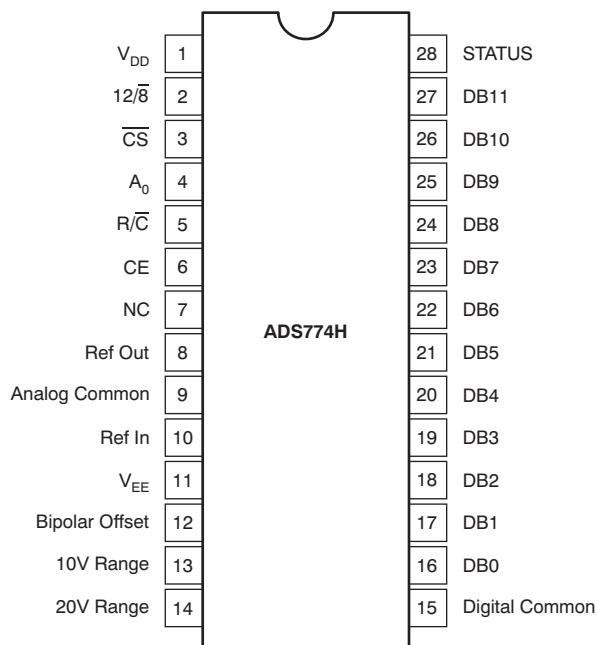
| SYMBOL    | PARAMETER                           | ADS774H |     |     | UNIT |
|-----------|-------------------------------------|---------|-----|-----|------|
|           |                                     | MIN     | TYP | MAX |      |
| $t_{DSC}$ | STS delay from CE                   |         | 60  | 200 | ns   |
| $t_{HEC}$ | CE pulse width                      | 50      | 30  |     | ns   |
| $t_{SSC}$ | $\overline{CS}$ to CE setup         | 50      | 20  |     | ns   |
| $t_{HSC}$ | $\overline{CS}$ low during CE high  | 50      | 20  |     | ns   |
| $t_{SRC}$ | $R/\overline{C}$ to CE setup        | 50      | 0   |     | ns   |
| $t_{HRC}$ | $R/\overline{C}$ low during CE high | 50      | 20  |     | ns   |
| $t_{SAC}$ | $A_0$ to CE setup                   | 0       |     |     | ns   |
| $t_{HAC}$ | $A_0$ valid during CE high          | 50      | 20  |     | ns   |

**TIMING REQUIREMENTS: Fully-Controlled Operation (Read Mode)**

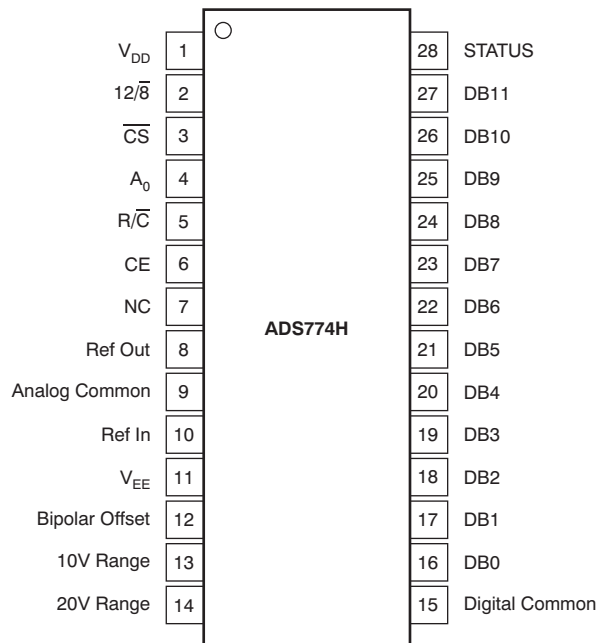
| SYMBOL    | PARAMETER                          | ADS774H |     |     | UNIT |
|-----------|------------------------------------|---------|-----|-----|------|
|           |                                    | MIN     | TYP | MAX |      |
| $t_{DD}$  | Access time from CE                |         | 75  | 150 | ns   |
| $t_{HD}$  | Data valid after CE low            | 25      | 35  |     | ns   |
| $t_{HL}$  | Output float delay                 |         | 100 | 150 | ns   |
| $t_{SSR}$ | $\overline{CS}$ to CE setup        | 50      | 0   |     | ns   |
| $t_{SRR}$ | $R/\overline{C}$ to CE setup       | 0       |     |     | ns   |
| $t_{SAR}$ | $A_0$ to CE setup                  | 50      | 25  |     | ns   |
| $t_{HSR}$ | $\overline{CS}$ valid after CE low | 0       |     |     | ns   |
| $t_{HRR}$ | $R/\overline{C}$ high after CE low | 0       |     |     | ns   |
| $t_{HAR}$ | $A_0$ valid after CE low           | 50      |     |     | ns   |
| $t_{HS}$  | STATUS delay after data valid      | 75      | 150 | 375 | ns   |

## PIN CONFIGURATION

**NT, NTD PACKAGES<sup>(1)</sup>**  
**DIP-28**  
**(TOP VIEW)**



**DW PACKAGE**  
**SO-28**  
**(TOP VIEW)**

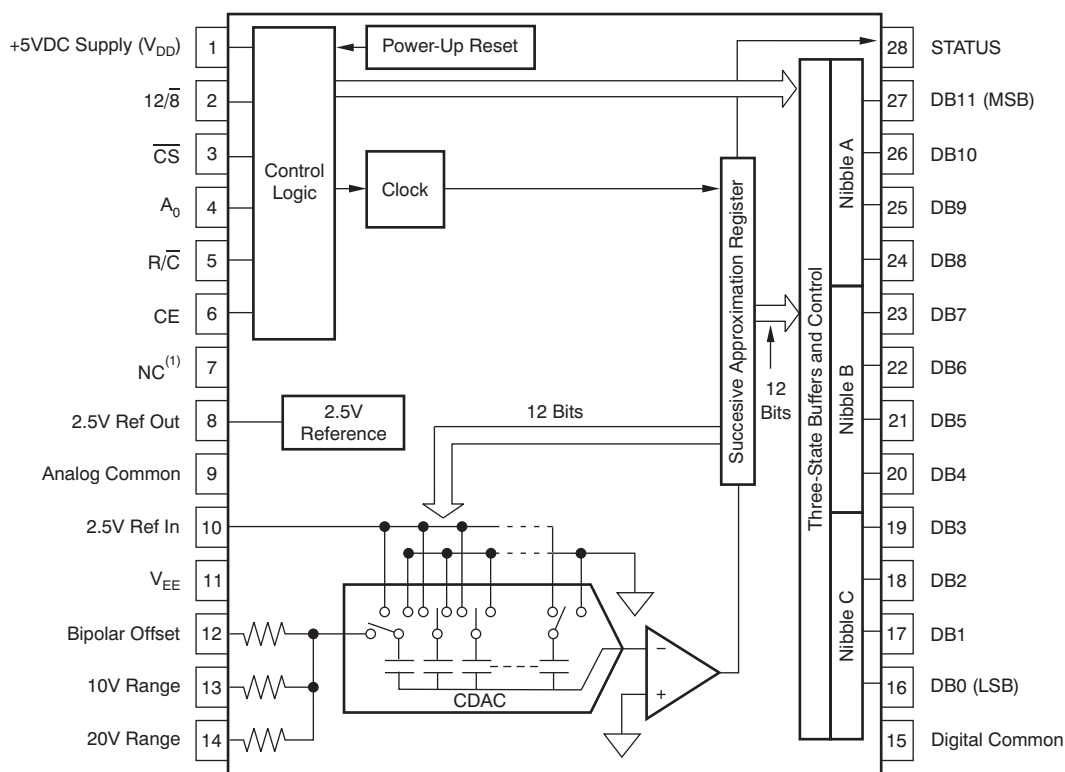


(1) NT and NTD (DIP-28) packages are product preview.

**PIN DESCRIPTIONS**

| <b>PIN</b>        |            | <b>I/O</b> | <b>DESCRIPTION</b>                                                                                                                                                             |
|-------------------|------------|------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>NAME</b>       | <b>NO.</b> |            |                                                                                                                                                                                |
| $V_{DD}$          | 1          | Power      | 5V digital logic supply                                                                                                                                                        |
| $12/\overline{8}$ | 2          | Input      | Data mode select<br>'1' = read<br>'0' = convert                                                                                                                                |
| $\overline{CS}$   | 3          | Input      | Chip select (active low)                                                                                                                                                       |
| $A_0$             | 4          | Input      | Byte address, short cycle                                                                                                                                                      |
| $R/\overline{C}$  | 5          | Input      | Read/Convert<br>'1' = 12-bit<br>'0' = 8-bit                                                                                                                                    |
| CE                | 6          | Input      | Chip enable (active high)                                                                                                                                                      |
| NC                | 7          |            | Do not connect                                                                                                                                                                 |
| Ref Out           | 8          | Output     | 2.5V reference output                                                                                                                                                          |
| Analog Common     | 9          | Power      | Analog ground                                                                                                                                                                  |
| Ref In            | 10         | Input      | 2.5V reference input                                                                                                                                                           |
| $V_{EE}$          | 11         | Power      | –15V to +5V analog supply                                                                                                                                                      |
| Bipolar Offset    | 12         | Input      | Connect this pin to REF OUT through a 50 $\Omega$ resistor for bipolar operation, or connect to Analog Common for unipolar operation.                                          |
| 10V Range         | 13         | Input      | 0V to 10V or $\pm 5V$ input span. Do not connect if using a 20V range.                                                                                                         |
| 20V Range         | 14         | Input      | 0V to 20V or $\pm 10V$ input span. Do not connect if using a 10V range.                                                                                                        |
| Digital Common    | 15         | Power      | Digital ground                                                                                                                                                                 |
| DB0               | 16         | Output     | These pins provide the lower four bits of data when $A_0$ is high. When $A_0$ is low, these pins/bits are disabled.                                                            |
| DB1               | 17         | Output     |                                                                                                                                                                                |
| DB2               | 18         | Output     |                                                                                                                                                                                |
| DB3               | 19         | Output     |                                                                                                                                                                                |
| DB4               | 20         | Output     | In 12-bit format, these pins output the middle four bits of data. In 8-bit format, they output the middle four bits when $A_0$ is low, and all 0's when $A_0$ is high.         |
| DB5               | 21         | Output     |                                                                                                                                                                                |
| DB6               | 22         | Output     |                                                                                                                                                                                |
| DB7               | 23         | Output     |                                                                                                                                                                                |
| DB8               | 24         | Output     | In 12-bit format, these pins output the upper four bits of data. In 8-bit format, they output the upper four bits when $A_0$ is low, and they are disabled when $A_0$ is high. |
| DB9               | 25         | Output     |                                                                                                                                                                                |
| DB10              | 26         | Output     |                                                                                                                                                                                |
| DB11              | 27         | Output     |                                                                                                                                                                                |
| STATUS            | 28         | Output     | Active high when conversion is in progress; active low when complete.                                                                                                          |

# FUNCTIONAL BLOCK DIAGRAM



NOTE (1): Not internally connected.

## Input Voltages, Transition Values, and LSB Values

| BINARY (BIN) OUTPUT             |                                            | INPUT VOLTAGE RANGE and MSB VALUES |                   |                   |                   |
|---------------------------------|--------------------------------------------|------------------------------------|-------------------|-------------------|-------------------|
| Analog Input Voltage Range      | Defined As:                                | $\pm 10V$                          | $\pm 5V$          | 0V to +10V        | 0V to +20V        |
| One least significant bit (LSB) | $\frac{FSR}{2^n}$                          | $\frac{20V}{2^n}$                  | $\frac{10V}{2^n}$ | $\frac{10V}{2^n}$ | $\frac{20V}{2^n}$ |
|                                 | n = 8                                      | 78.13mV                            | 39.06mV           | 39.06mV           | 78.13mV           |
|                                 | n = 12                                     | 4.88mV                             | 2.44mV            | 2.44mV            | 4.88mV            |
| Output transition values        |                                            |                                    |                   |                   |                   |
| FFEH to FFFh                    | +Full-scale calibration                    | +10V – 3/2LSB                      | +5V – 3/2LSB      | +10V – 3/2LSB     | +20V – 3/2LSB     |
| 7FFFh to 800h                   | Midscale calibration (Bipolar offset)      | 0V – 1/2LSB                        | 0V – 1/2LSB       | +5V – 1/2LSB      | +10V – 1/2LSB     |
| 000h to 001h                    | Zero calibration (–Full-scale calibration) | –10V – +1/2LSB                     | –5V + 1/2LSB      | 0V + 1/2LSB       | 0V + 1/2LSB       |

## TYPICAL CHARACTERISTICS

At  $T_A = +25^\circ\text{C}$ ;  $V_{DD} = V_{EE} = +5\text{V}$ , bipolar  $\pm 10\text{V}$  input range, and sampling frequency of  $110\text{kHz}$ , unless otherwise specified.  
All plots use 4096 point FFTs.

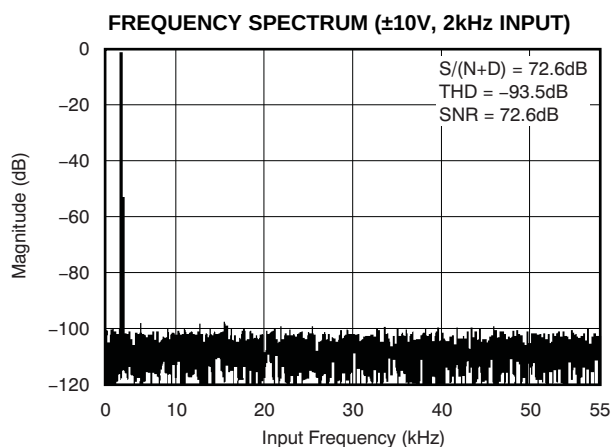


Figure 5.

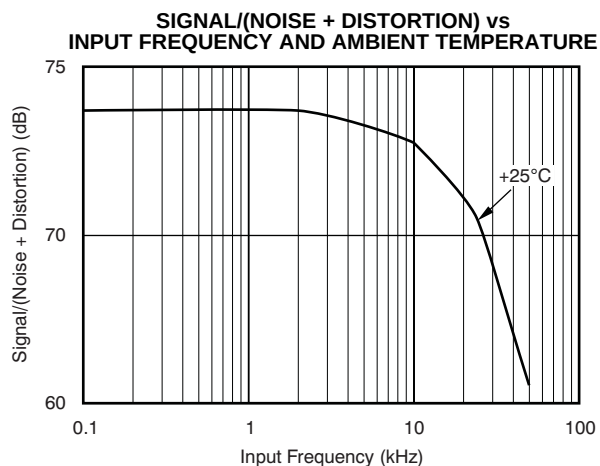


Figure 6.

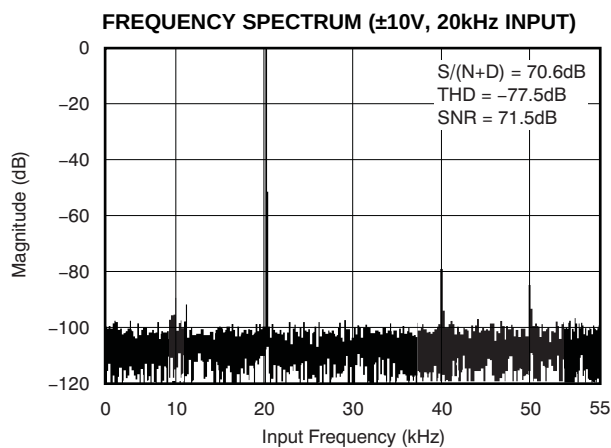


Figure 7.

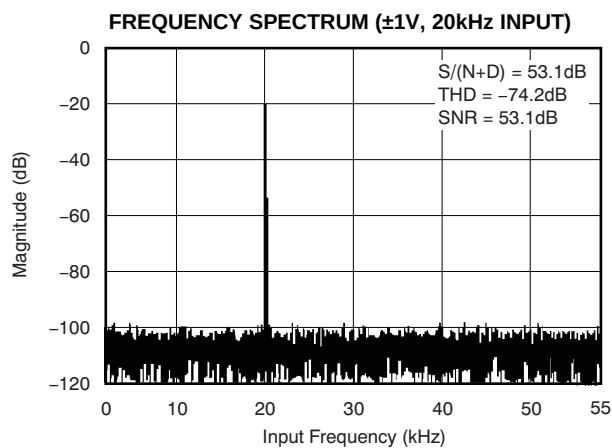


Figure 8.

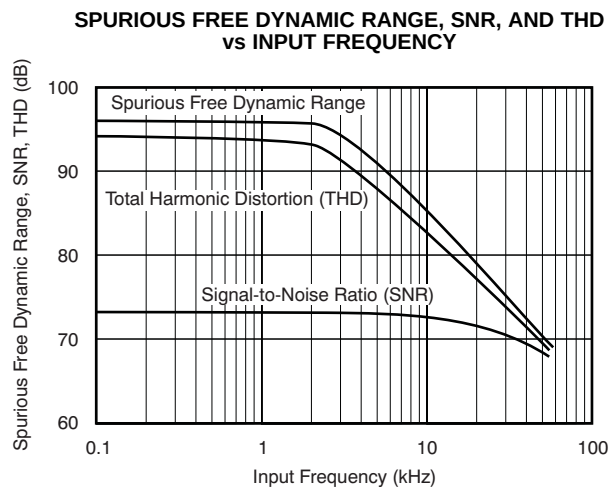


Figure 9.

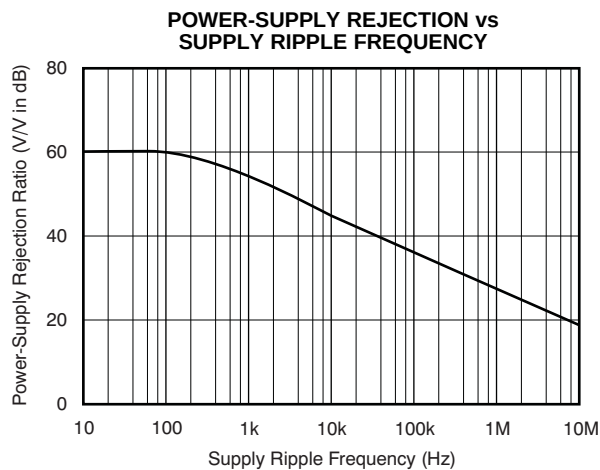


Figure 10.

## THEORY OF OPERATION

### OVERVIEW

In the ADS774H, the advantages of advanced CMOS technology (such as high logic density, stable capacitors, and precision analog switches) produce a fast, low-power ADC with internal sample/hold.

The charge-redistribution successive-approximation circuitry converts analog input voltages into digital words.

A simple example of a charge-redistribution ADC with only three bits is shown in [Figure 11](#).

### SAMPLING

While sampling, the capacitor array switch for the MSB capacitor ( $S_1$ ) is in position  $S$ , so that the charge on the MSB capacitor is proportional to the voltage level of the analog input signal. The remaining array switches ( $S_2$  and  $S_3$ ) are set to position  $G$ . Switch  $S_C$  is closed, setting the comparator input offset to zero.

### CONVERSION

When a conversion command is received, switch  $S_1$  opens to capture a charge on the MSB capacitor proportional to the analog input level at the time of the sampling command, and switch  $S_C$  opens to float the comparator input. The charge held in the capacitor array can now be moved between the three capacitors in the array by connecting switches  $S_1$ ,  $S_2$ , and  $S_3$  to either the  $R$  position (to connect to the reference) or the  $G$  position (to connect to GND), thus changing the voltage generated at the comparator input.

During the first approximation, the MSB capacitor is connected through switch  $S_1$  to the reference, while switches  $S_2$  and  $S_3$  are connected to GND. Depending on whether the comparator output is high or low, the logic then latches  $S_1$  in position  $R$  or  $G$ . Similarly, the second approximation is made by connecting  $S_2$  to the reference and  $S_3$  to GND, and latching  $S_2$  according to the output of the comparator. After three successive approximation steps have been made, the voltage level at the comparator is within  $1/2\text{LSB}$  of GND, and a digital word that represents the analog input can be determined from the positions of  $S_1$ ,  $S_2$  and  $S_3$ .

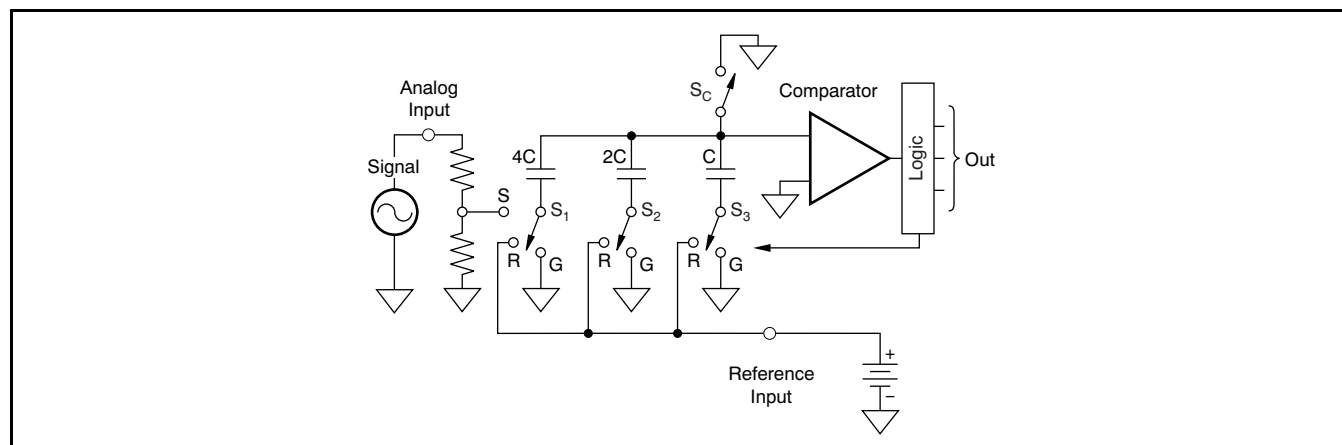


Figure 11. 3-Bit Charge Redistribution ADC

## DEVICE OPERATION

### BASIC OPERATION

Figure 12 shows the minimum connections required to operate the ADS774H in a basic  $\pm 10\text{V}$  range in the Control Mode (discussed in detail in the section, *Sample/Hold (S/H) Control Mode and ADC774 Emulation Mode*). The falling edge of a Convert Command (a pulse that takes pin 5 low for a minimum of 25ns) initiates two actions: first, it switches the ADS774H input to the hold state; second, it begins the conversion process. Pin 28 (STATUS) outputs *high* during the conversion, and falls only after the conversion is completed and the data have been latched on the data output pins (pins 16 to 27). Thus, the falling edge of STATUS on pin 28 can be used to read the data from the conversion. Also, during conversion, the STATUS signal puts the

data output pins into a high-Z state and inhibits the input lines. This condition means that pulses on pin 5 are ignored, so that new conversions cannot be initiated during the conversion, either as a result of spurious signals or to short-cycle the ADS774H.

The ADS774H begins acquiring a new sample as soon as the conversion completes, even before the STATUS output falls, and tracks the input signal until the next conversion is started. The ADS774H is designed to complete a conversion and accurately acquire a new signal in  $8.5\mu\text{s}$  (max) over the full operating temperature range, so that conversions can take place at a full 117kHz.

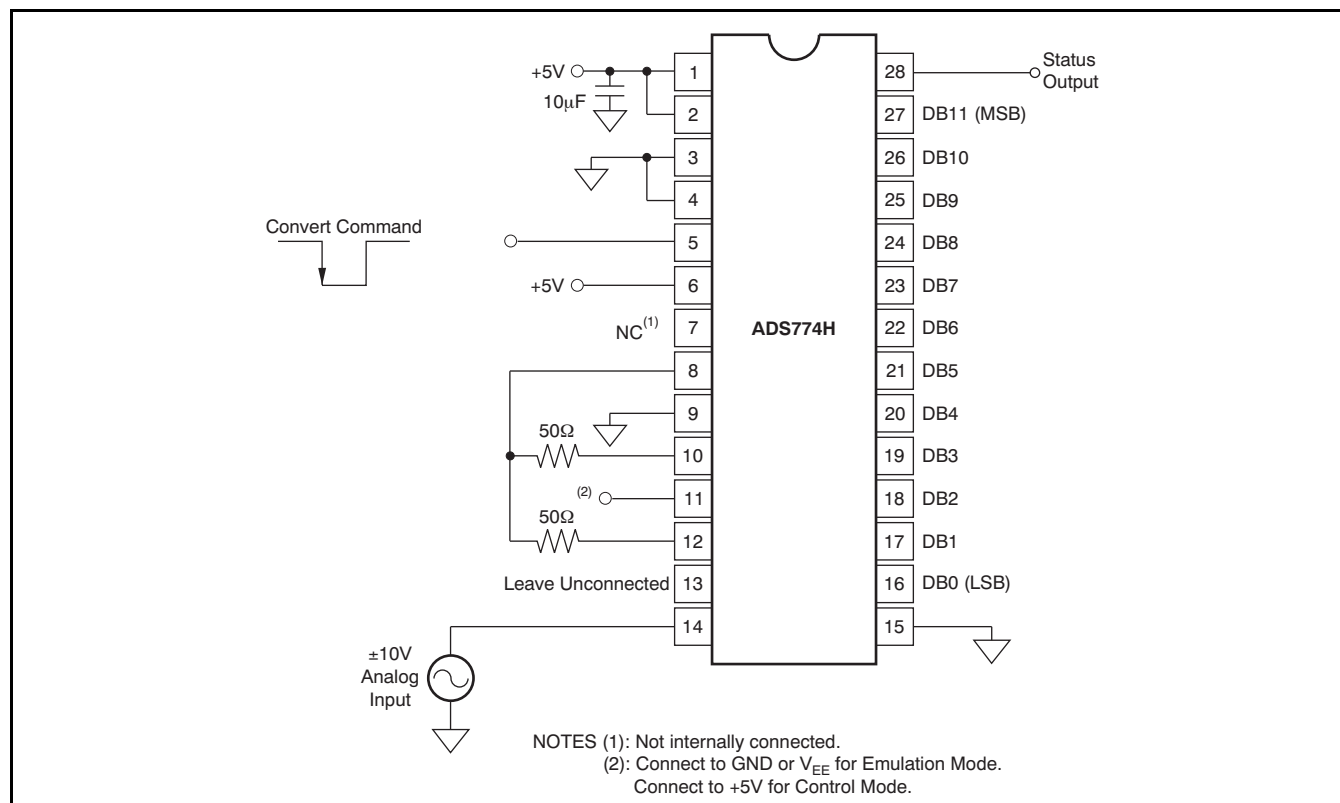


**Figure 12. Basic  $\pm 10\text{V}$  Operation**

## CONTROLLING THE ADS774H

The ADS774H can easily interface with most microprocessors and other digital systems. The microprocessor may take full control of each conversion, or the converter may operate in a stand-alone mode, controlled only by the  $R/\overline{C}$  input. Full control consists of selecting an 8- or 12-bit conversion cycle, initiating the conversion, and

reading the output data when ready: choosing either 12 bits all at once, or the eight MSBs followed by the four LSBs in a left-justified format. The five control inputs ( $12/\overline{8}$ ,  $\overline{CS}$ ,  $A_0$ ,  $R/\overline{C}$ , and  $CE$ ) are all TTL-/CMOS-compatible. The functions of the control inputs are described in [Table 1](#). The control function truth table is shown in [Table 2](#).

**Table 1. Control Line Functions**

| DESIGNATION               | DEFINITION                                      | FUNCTION                                                                                                                                                                                                                                                                 |
|---------------------------|-------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| $CE$ (pin 6)              | Chip Enable (active high)                       | Must be high ('1') to either initiate a conversion or read output data. 0-to-1 edge may be used to initiate a conversion.                                                                                                                                                |
| $\overline{CS}$ (pin 3)   | Chip Select (active low)                        | Must be low ('0') to either initiate a conversion or read output data. 1-to-0 edge may be used to initiate a conversion.                                                                                                                                                 |
| $R/\overline{C}$ (pin 5)  | Read/Convert<br>'1' = Read<br>'0' = Convert     | Must be low ('0') to initiate either 8- or 12-bit conversions. 1-to-0 edge may be used to initiate a conversion.<br>Must be high ('1') to read output data. 0-to-1 edge may be used to initiate a read operation.                                                        |
| $A_0$ (pin 4)             | Byte Address, short cycle                       | In the start-convert mode, $A_0$ selects either 8-bit ( $A_0 = '1'$ ) or 12-bit ( $A_0 = '0'$ ) conversion mode. When reading output data in two 8-bit bytes, $A_0 = '0'$ accesses eight MSBs (high byte) and $A_0 = '1'$ accesses four LSBs and trailing 0s (low byte). |
| $12/\overline{8}$ (pin 2) | Data Mode select<br>'1' = 12-bit<br>'0' = 8-bit | When reading output data, $12/\overline{8} = '1'$ enables all 12 output bits simultaneously. $12/\overline{8} = '0'$ enables the MSBs or LSBs as determined by the $A_0$ line.                                                                                           |

**Table 2. Control Input Truth Table**

| $CE$ | $\overline{CS}$ | $R/\overline{C}$ | $12/\overline{8}$ | $A_0$ | OPERATION                                  |
|------|-----------------|------------------|-------------------|-------|--------------------------------------------|
| 0    | X               | X                | X                 | X     | None                                       |
| X    | 1               | X                | X                 | X     | None                                       |
| ↑    | 0               | 0                | X                 | 0     | Initiate 12-bit conversion                 |
| ↑    | 0               | 0                | X                 | 1     | Initiate 8-bit conversion                  |
| 1    | ↓               | 0                | X                 | 0     | Initiate 12-bit conversion                 |
| 1    | ↓               | 0                | X                 | 1     | Initiate 8-bit conversion                  |
| 1    | 0               | ↓                | X                 | 0     | Initiate 12-bit conversion                 |
| 1    | 0               | ↓                | X                 | 1     | Initiate 8-bit conversion                  |
| 1    | 0               | 1                | 1                 | X     | Enable 12-bit output                       |
| 1    | 0               | 1                | 0                 | 0     | Enable eight MSBs only                     |
| 1    | 0               | 1                | 0                 | 1     | Enable four LSBs plus four trailing zeroes |

## STAND-ALONE OPERATION

For stand-alone operation, control of the converter is accomplished by a single control line connected to  $R/\overline{C}$ . In this mode,  $\overline{CS}$  and  $A_0$  are connected to digital common, and CE and  $12/\overline{8}$  are connected to +5V. The output data are presented as 12-bit words. Stand-alone mode is used in systems that contain dedicated input ports which do not require full bus interface capability.

Conversion is initiated by a high-to-low transition of  $R/\overline{C}$ . The three-state data output buffers are enabled when  $R/\overline{C}$  is high and STATUS is low. Thus, there are two possible modes of operation: data can be read with either a positive pulse on  $R/\overline{C}$ , or a negative pulse on STATUS. In either case, the  $R/\overline{C}$  pulse must remain low for a minimum of 25ns.

Figure 1 illustrates timing with an  $R/\overline{C}$  pulse that goes low and returns high during the conversion. In this case, the three-state outputs go to the high-impedance state in response to the falling edge of  $R/\overline{C}$  and are enabled for external access of the data after the conversion completes.

Figure 2 illustrates the timing when a positive  $R/\overline{C}$  pulse is used. In this mode, the output data from the previous conversion are enabled during the time  $R/\overline{C}$  is high. A new conversion starts on the falling edge of  $R/\overline{C}$ , and the three-state outputs return to the high-impedance state until the next occurrence of a high  $R/\overline{C}$  pulse. Timing specifications for stand-alone operation are listed in the Timing Requirements table for [Stand-Alone Mode](#).

## FULLY-CONTROLLED OPERATION

### Conversion Length

Conversion length (8-bit or 12-bit) is determined by the state of the  $A_0$  input, which is latched upon receipt of a conversion start transition (described in the next section). If  $A_0$  is latched high, the conversion continues for eight bits. The full 12-bit conversion occurs if  $A_0$  is low. If all 12 bits are read following an 8-bit conversion, the four LSBs (DB0–DB3) are low (logic 0).  $A_0$  is latched because it is also involved in enabling the output buffers. No other control inputs are latched.

## CONVERSION START

The converter initiates a conversion based on a transition that occurs on any of three logic inputs (CE,  $\overline{CS}$ , and  $R/\overline{C}$ ) as shown in [Table 2](#). Conversion is initiated by the last of the three inputs to reach the required state; therefore, all three inputs may be dynamically controlled. If necessary, all three inputs may change state simultaneously; in this case, the nominal delay time is the same regardless of which input actually starts the conversion. If it is desired that a particular input establish the actual start of conversion, the other two inputs should be stable for a minimum of 50ns before the transition of the critical input. Timing relationships for the start of conversion are illustrated in [Figure 3](#). The timing specifications for timing are listed in the Timing Requirements tables for Fully-Controlled Operation [Convert Mode](#) and [Read Mode](#).

The STATUS output indicates the current state of the converter because it is in a high state only during conversion. During this time the three-state output buffers remain in a high-impedance state, and therefore data cannot be read during conversion. Furthermore, during this period, additional transitions of the three digital inputs that control conversion are ignored, so that conversion cannot be prematurely terminated or restarted. However, if  $A_0$  changes state after the beginning of the conversion, any additional start conversion transition will latch the new state of  $A_0$ , and possibly generate an incorrect conversion length (8 bits as opposed to 12 bits) for that conversion.

## READING OUTPUT DATA

After conversion is initiated, the output data buffers remain in a high-impedance state until the following four logic conditions are simultaneously met:  $R/\overline{C}$  high, STATUS low, CE high, and  $\overline{CS}$  low. Upon satisfying these conditions, the data lines are enabled according to the state of inputs  $12/\overline{8}$  and  $A_0$ . See [Figure 4](#) for the timing diagram, and the Timing Requirements tables for Fully-Controlled Operation [Convert Mode](#) and [Read Mode](#) for timing specifications.

In most applications, the  $12/\bar{8}$  input is hard-wired in either the high or low condition, although it is fully TTL- and CMOS-compatible and may be actively driven if desired. When  $12/\bar{8}$  is high, all 12 output lines (DB0 to DB11) are enabled simultaneously for full data word transfer to a 12-bit or 16-bit bus. In this situation, the  $A_0$  state is ignored when reading the data.

When  $12/\bar{8}$  is low, the data is presented in the form of two 8-bit bytes, with selection of the byte of interest accomplished by the state of  $A_0$  during the read cycle. When  $A_0$  is low, the byte addressed contains the eight MSBs. When  $A_0$  is high, the byte addressed

contains the four LSBs from the conversion followed by four logic zeroes that have been forced by the control logic. The left-justified formats of the two 8-bit bytes are shown in Table 3. Connection of the ADS774H to an 8-bit bus for data transfer is illustrated in Figure 13. The design of the ADS774H ensures that the  $A_0$  input may be toggled at any time with no damage to the converter; the outputs that are tied together in Figure 13 cannot be enabled at the same time. The  $A_0$  input is usually driven by the least significant bit of the address bus to allow storage of the output data word in two consecutive memory locations.

**Table 3. 12-Bit Data Format for 8-Bit Systems**

| Word 1    |      |      |     |     |     |     |     |     |
|-----------|------|------|-----|-----|-----|-----|-----|-----|
| Processor | DB7  | DB6  | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
| Converter | DB11 | DB10 | DB9 | DB8 | DB7 | DB6 | DB5 | DB4 |

| Word 2    |     |     |     |     |     |     |     |     |
|-----------|-----|-----|-----|-----|-----|-----|-----|-----|
| Processor | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
| Converter | DB3 | DB2 | DB1 | DB0 | 0   | 0   | 0   | 0   |

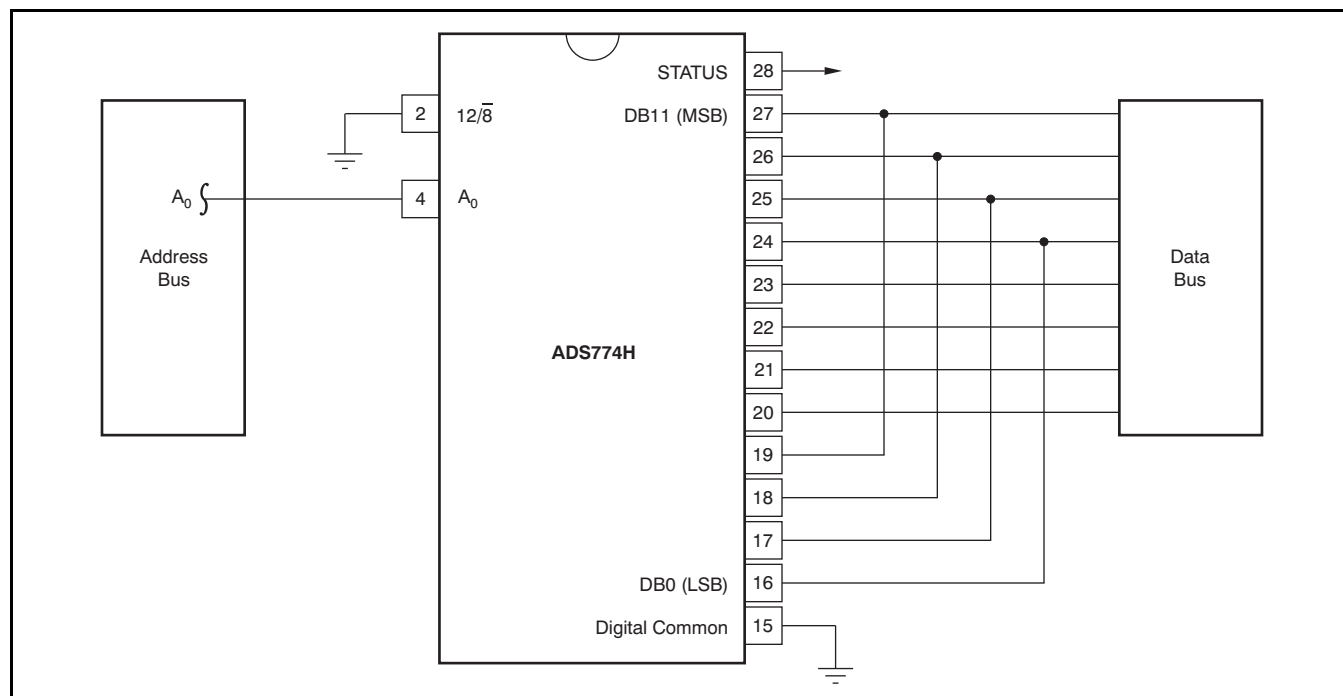


**Figure 13. Connection to an 8-Bit Bus**

## SAMPLE/HOLD (S/H) CONTROL MODE AND ADC774 EMULATION MODE

As with the ADS774, Emulation Mode allows the ADS774H to be dropped into most existing ADC774 sockets without changes to other system hardware or software. In existing sockets, the analog input is held stable during the conversion period so that accurate conversions can proceed, but the input can change rapidly at any time before the conversion starts. Emulation Mode uses the stability of the analog input during the conversion period to both acquire and convert in a maximum of  $8\mu\text{s}$  ( $8.5\mu\text{s}$  over temperature.) In fact, system throughput can be increased, because the input to the ADS774H can start slewing before the end of a conversion (after the acquisition time), which is not possible with existing ADC774s.

The Control Mode is provided to allow full use of the internal sample/hold, eliminating the need for an external sample/hold in most applications. As compared with systems using separate sample/hold and ADC stages, the ADS774H in the Control Mode also eliminates the need for one of the control signals, usually the convert command. The command that puts the internal sample/hold in the hold state also initiates a conversion, reducing timing constraints in many systems.

The basic difference between these two modes is the assumptions about the state of the input signal both before and during the conversion. These differences are shown in Figure 14 and Table 4. In the Control Mode, it is assumed that during the required  $1.4\mu\text{s}$  acquisition time, the signal is not changing faster than the ADS774H can track. No assumption is made

about the input level after the convert command arrives, because the input signal is sampled and conversion begins immediately after the convert command. This architecture means that a convert command can also be used to switch an input multiplexer or change gains on a programmable gain amplifier, allowing the input signal to settle before the next acquisition at the end of the conversion. Because aperture jitter is minimized in the Control Mode, a high input frequency can be converted without an external sample/hold.

In the Emulation Mode, a delay time is introduced between the convert command and the start of conversion to allow the ADS774H enough time to acquire the input signal before converting. This delay time increases the effective aperture delay time from  $0.02\mu\text{s}$  to  $1.6\mu\text{s}$ , but allows the ADS774H to replace the ADC774 in most circuits without additional changes. In designs where the input to the ADS774H is changing rapidly in the  $200\text{ns}$  before a convert command, system performance may be enhanced by delaying the convert command by  $200\text{ns}$ .

When using the ADS774H in the Emulation Mode to replace existing converters in current designs, a sample/hold amplifier often precedes the converter. In these cases, no additional delay in the convert command is needed. The existing sample/hold does not slew excessively when going from the sample mode to the hold mode before a conversion. In both modes, as soon as the conversion completes, the internal sample/hold circuit immediately begins slewing to track the input signal.

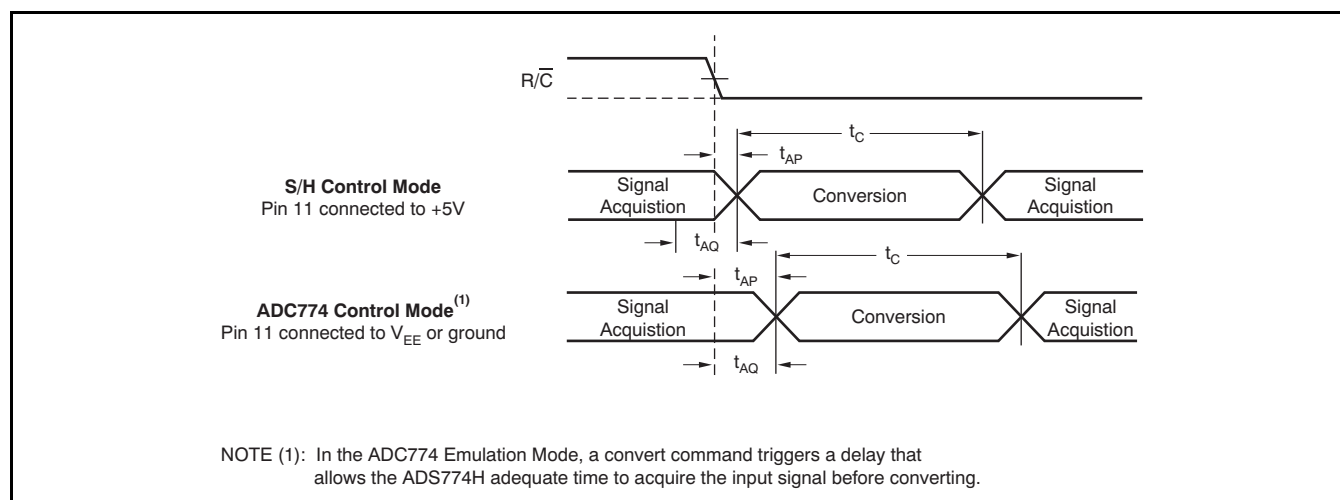


**Figure 14. Signal Acquisition and Conversion Timing**

**Table 4. Conversion Timing,  $T_{MIN}$  to  $T_{MAX}$** 

| SYMBOL                           | PARAMETER            | S/H CONTROL MODE<br>(Pin 11 Connected to +5V) |     |     | ADC774 EMULATION MODE<br>(Pin 11 Connected to 0V to –15V) |      |     | UNIT |
|----------------------------------|----------------------|-----------------------------------------------|-----|-----|-----------------------------------------------------------|------|-----|------|
|                                  |                      | MIN                                           | TYP | MAX | MIN                                                       | TYP  | MAX |      |
| Throughput Time:                 |                      |                                               |     |     |                                                           |      |     |      |
| t <sub>AQ</sub> + t <sub>C</sub> | 12-bit conversions   |                                               | 8   | 8.5 |                                                           | 8    | 8.5 | μs   |
|                                  | 8-bit conversions    |                                               | 6   | 6.3 |                                                           | 6    | 6.3 | μs   |
| Conversion Time:                 |                      |                                               |     |     |                                                           |      |     |      |
| t <sub>C</sub>                   | 12-bit conversions   |                                               | 6.4 |     |                                                           | 6.4  |     | μs   |
|                                  | 8-bit conversions    |                                               | 4.4 |     |                                                           | 4.4  |     | μs   |
| t <sub>AQ</sub>                  | Acquisition time     |                                               | 1.4 |     |                                                           | 1.4  |     | μs   |
| t <sub>AP</sub>                  | Aperture delay       |                                               | 20  |     |                                                           | 1600 |     | ns   |
| t <sub>J</sub>                   | Aperture uncertainty |                                               | 0.3 |     |                                                           | 10   |     | ns   |

## INSTALLATION

### LAYOUT CONSIDERATIONS

Analog (pin 9) and digital (pin 15) commons are not connected together internally in the ADS774H, but should be connected together as close to the unit as possible, and to an analog common ground plane beneath the converter on the component side of the board. In addition, a wide conductor pattern should run directly from pin 9 to the analog supply common, and a separate wide conductor pattern from pin 15 to the digital supply common.

If the single-point system common cannot be established directly at the converter, pin 9 and pin 15 must be connected together at the converter. A single wide conductor pattern then connects these two pins to the system common. In either case, the common return of the analog input signal should be referenced to pin 9 of the ADC. This configuration prevents any voltage drops that may occur in the power-supply common returns from appearing in series with the input signal.

The speed of the ADS774H requires special caution regarding whichever input pin is not used. For 10V input ranges, pin 14 (20V range) must be unconnected; for 20V input ranges, pin 13 (10V range) must be unconnected. In both cases, the unconnected input should be shielded with a ground plane to reduce noise pickup.

In particular, the unused input pin should not be connected to any capacitive load, including high-impedance switches. Even a few picofarads on the unused pin can degrade acquisition time.

Coupling between analog input and digital lines should be minimized by careful layout. For instance, if the lines must cross, these traces should do so at right angles. Parallel analog and digital lines should be separated from each other by a pattern connected to common. If external full-scale and offset potentiometers are used, the potentiometers and associated resistors should be located as close as possible to the ADS774H.

### POWER-SUPPLY DECOUPLING

On the ADS774H, +5V (to Pin 1) is the only power supply required for correct operation. Pin 7 is not connected internally, so there is no problem in existing ADC774 sockets where this is connected to +15V. Pin 11 ( $V_{EE}$ ) is only used as a logic input to select modes of control over the sampling function as described above. When used in an existing ADC774 socket, the –15V on pin 11 selects the ADC774 Emulation Mode. Pin 11 is used as a logic input; therefore, it is immune to typical supply variations.

The +5V supply should be bypassed with a 10 $\mu$ F tantalum capacitor located close to the converter to promote noise-free operations, as shown in [Figure 12](#). Noise on the power-supply lines can degrade the converter performance. Noise and spikes from a switching power supply are especially troublesome.

### RANGE CONNECTIONS

The ADS774H offers four standard input ranges: 0V to +10V, 0V to +20V,  $\pm 5$ V, or  $\pm 10$ V. [Figure 15](#) and [Figure 16](#) show the necessary connections for each of these ranges, along with the optional gain and offset trim circuits. If a 10V input range is required, the analog input signal should be connected to pin 13 of the converter. A signal that requires a 20V range is connected to pin 14. In either case, the other pin of the two is left unconnected. Pin 12 (Bipolar Offset) is connected either to Pin 9 (Analog Common) for unipolar operation, or to Pin 8 (2.5V Ref Out), or the external reference, for bipolar operation. Full-scale and offset adjustments are described in the [Optional External Full-Scale and Offset Adjustments](#) section.

The input impedance of the ADS774H is typically 50k $\Omega$  in the 20V ranges and 12k $\Omega$  in the 10V ranges.

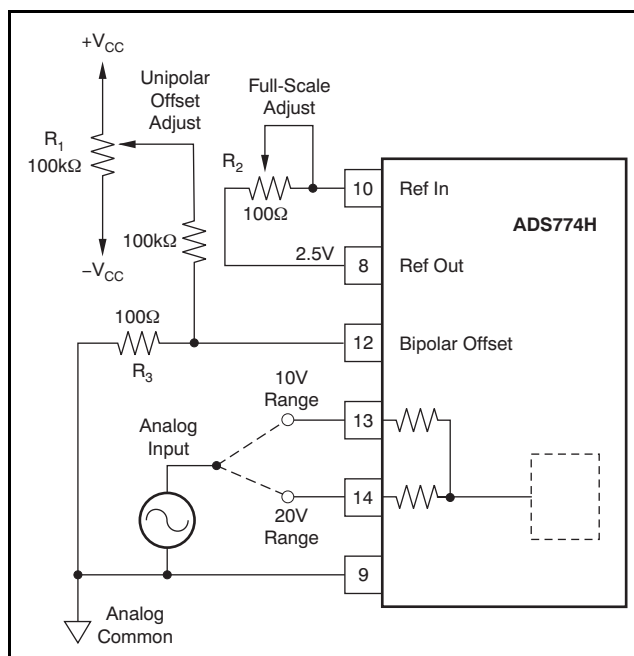
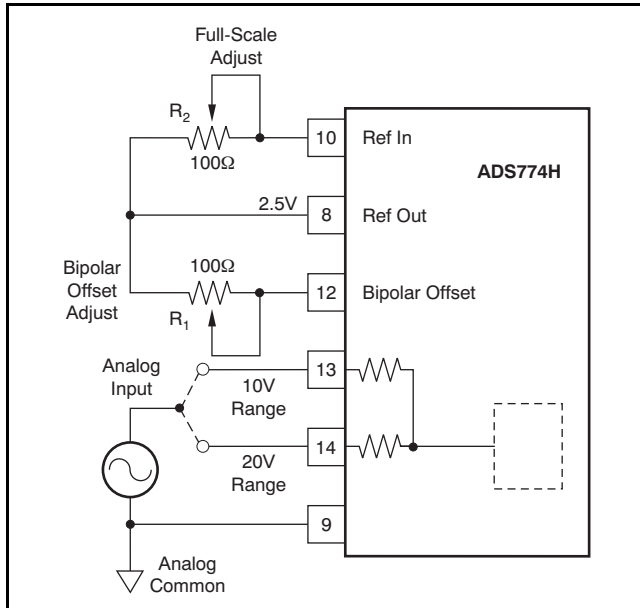


Figure 15. Unipolar Configuration

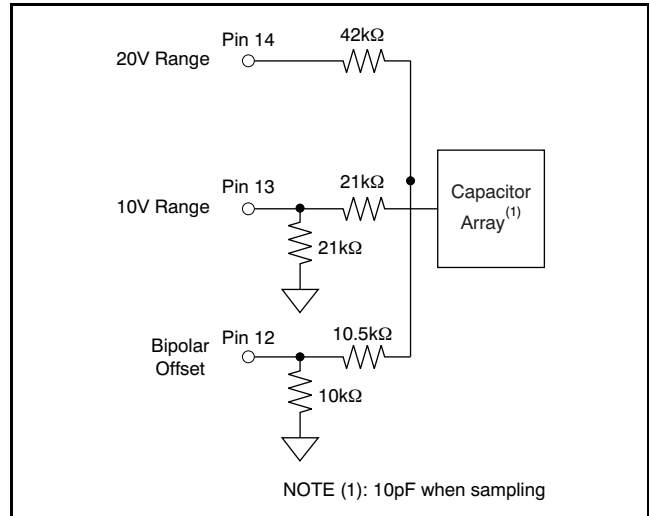


### Figure 16. Bipolar Configuration

## INPUT STRUCTURE

Figure 17 shows the resistor divider input structure of the ADS774H. Because the input is driving a capacitor in the CDAC during acquisition, the input is looking into a high impedance node.

To understand how this circuit works, it is necessary to know that the input range on the internal sampling capacitor is from 0V to +3.33V, and that the analog input to the ADS774H must be converted to this range. The unipolar 20V range can be used as an example of how the divider network functions. In 20V operation, the analog input goes into pin 14. Pin 13 is left unconnected and pin 12 is connected to pin 9, analog common. From [Figure 17](#), it is clear that the input to the capacitor array is the analog input voltage on pin 14 divided by the resistor network ( $42k\Omega + 42k\Omega \parallel 10.5k\Omega$ ). A 20V input at pin 14 is divided to 3.33V at the capacitor array, while a 0V input at pin 14 gives 0V at the capacitor array.



### Figure 17. ADS774H Input Structure

## SINGLE-SUPPLY OPERATION

The ADS774H is designed to operate from a single +5V supply and work with all of the unipolar and bipolar input ranges, in either Control Mode or Emulation Mode, as described in the [\*Sample/Hold \(S/H\) Control Mode and ADC744 Emulation Mode\*](#) section. Pin 7 is not connected internally. This input is where +12V or +15V is supplied on traditional ADC774s. Pin 11, the -12V or -15V supply input on traditional ADC774s, is used only as a logic input on the ADS774H. There is a resistor divider internally on pin 11 to reduce that input to a correct logic level within the ADS774H, and this resistor will add 10mW to 15mW to the power consumption of the ADS774H when -15V is supplied to pin 11. To minimize power consumption in a system, pin 11 can be simply grounded (for Emulation Mode) or tied to +5V (for Control Mode.)

There are no other modifications required for the ADS774H to function with a single +5V supply.

## CALIBRATION

### Optional External Full-Scale and Offset Adjustments

Offset and full-scale errors may be trimmed to zero using external offset and full-scale trim potentiometers connected to the ADS774H as shown in [Figure 15](#) and [Figure 16](#), respectively, for unipolar and bipolar operation.

#### Calibration Procedure: Unipolar Ranges

If external adjustments of full-scale and offset are not required, replace  $R_2$  in [Figure 15](#) with a  $50\Omega$  1% metal film resistor and connect pin 12 to pin 9, omitting the other adjustment components.

If adjustment is required, connect the converter as shown in [Figure 15](#). Sweep the input through the end-point transition voltage ( $0V + 1/2LSB$ ;  $+1.22mV$  for the 10V range,  $+2.44mV$  for the 20V range) that causes the output code to be  $DB0$  on (high). Adjust potentiometer  $R_1$  until  $DB0$  alternately toggles on and off with all other bits off. Then, adjust the full-scale by applying an input voltage of nominal full-scale minus

$3/2LSB$ , the value that should cause all bits to be on. This value is  $+9.9963V$  for the 10V range and  $+19.9927V$  for the 20V range. Adjust potentiometer  $R_2$  until bits  $DB1$  to  $DB11$  are on, and  $DB0$  is toggling on and off.

#### Calibration Procedure: Bipolar Ranges

If external adjustments of full-scale and bipolar offset are not required, replace the potentiometers in [Figure 16](#) by  $50\Omega$ , 1% metal film resistors.

If adjustments are required, connect the converter as shown in [Figure 16](#). The calibration procedure is similar to that described above for unipolar operation, except that the offset adjustment is performed with an input voltage that is  $1/2LSB$  above the minus full-scale value ( $-4.9988V$  for the  $\pm 5V$  range,  $-9.9976V$  for the  $\pm 10V$  range). Adjust  $R_1$  for  $DB0$  to toggle on and off with all other bits off. To adjust the full-scale range, apply a dc input signal that is  $3/2LSB$  below the nominal plus full-scale value ( $+4.9963V$  for  $\pm 5V$  range,  $+9.9927V$  for  $\pm 10V$  range) and adjust  $R_2$  for  $DB0$  to toggle on and off with all other bits off.

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup>    | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| ADS774HIBDW      | NRND                  | SOIC         | DW              | 28   | 20          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-2-260C-1 YEAR          |                             |
| ADS774HIBDWR     | NRND                  | SOIC         | DW              | 28   | 1000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-2-260C-1 YEAR          |                             |
| ADS774HIDW       | NRND                  | SOIC         | DW              | 28   | 20          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-2-260C-1 YEAR          |                             |
| ADS774HIDWR      | NRND                  | SOIC         | DW              | 28   | 1000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-2-260C-1 YEAR          |                             |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

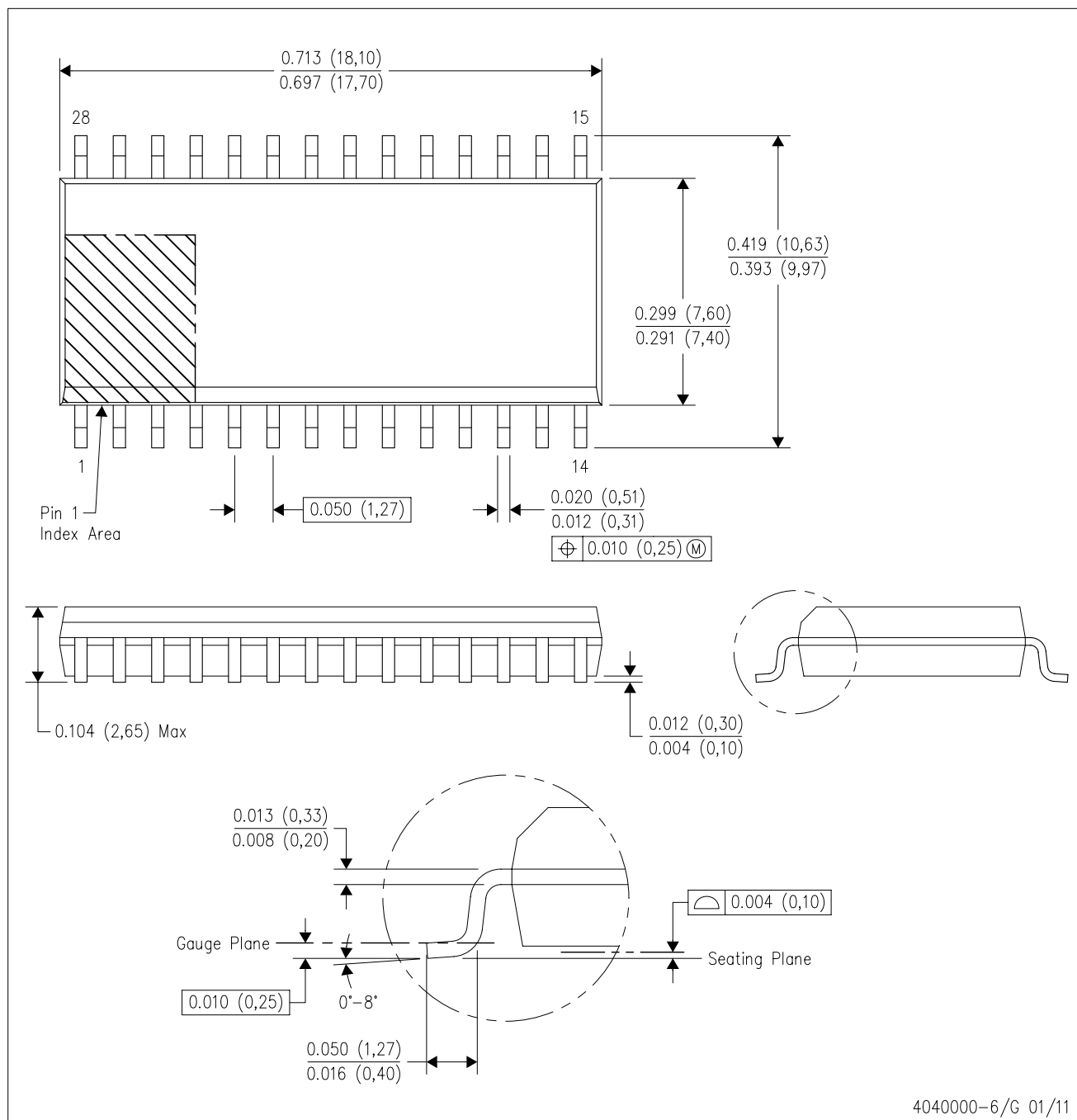
<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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DW (R-PDSO-G28)

## PLASTIC SMALL OUTLINE



- NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.  
B. This drawing is subject to change without notice.  
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
D. Falls within JEDEC MS-013 variation AE.

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|                               |                                                                                          |
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